

15BJ58CA-B Transient Voltage Suppressor

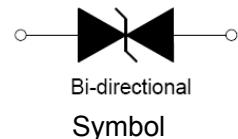
Rev.B-1

DESCRIPTION:

15BJ58CA-B is designed for DC 48V, POE supply equipment, It is used to replace the SMDJ series TVS, also can be solved the POE normal solution which use TSPD.



SMBF



FEATURES:

- ✧ Low profile package.
- ✧ None negative resistance.
- ✧ Excellent clamping capability.
- ✧ Glass passivated junction.
- ✧ High temperature reflow soldering: 260°C/40s at terminals.
- ✧ Plastic package has underwriters laboratory flammability 94V-0.
- ✧ Meets MSL level 1, per J-STD-020, LF maximum peak of 260°C.
- ✧ Terminal: solder plated, solderable per J-STD-002.
- ✧ For surface mounted applications in order to optimize board space.

SURGE LEVEL

- ✧ 10/700μs 40ohm 4KV
- ✧ 1.2/50μs-8/20μs 2ohm 1KV

ABSOLUTE MAXIMUM RATINGS($T_A=25^\circ\text{C}$, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage and operating junction temperature range	T_{STG}/T_J	-55 to +150	°C
Peak pulse power dissipation at 10/1000μs waveform	P_{PP}	3000	W
Steady state power dissipation at $T_L=75^\circ\text{C}$	$P_{M(AV)}$	5.0	W
Peak pulse voltage at 10/700μs@40Ω waveform	V_{PP}	4000	V
Peak pulse voltage at 1.2/50μs-8/20μs@2Ω waveform	V_{PP}	1000	V

MARKING

BF58C: Device Marking Code
1935: the 35th week, 2019

ELECTRICAL CHARACTERISTICS($T_A=25^\circ\text{C}$)

Part Number	Marking	V_R	$I_{R@V_R}$	$V_{BR}@I_T$		I_T	$V_c@10/700\mu\text{s}$ 4KV/40Ω	$V_c@1.2/50\mu\text{s}$ 8/20μs 1KV/2Ω	$V_c@I_{PP}^{(1)}$	$I_{PP}^{(1)}$
Bi-polar	Bi-polar	V	μA	min(V)	max(V)	mA	max(V)	max(V)	max(V)	A
15BJ58CA-B	BF58C	58	1	64.4	71.2	1	100	105	90	32

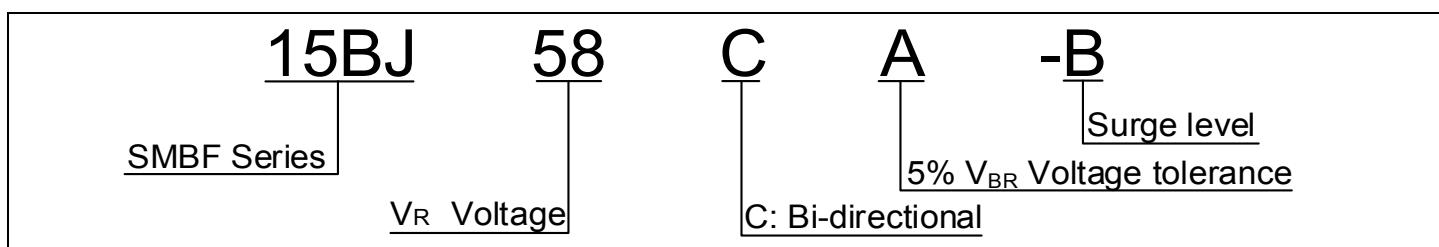
(1) Surge waveform: 10/1000μs

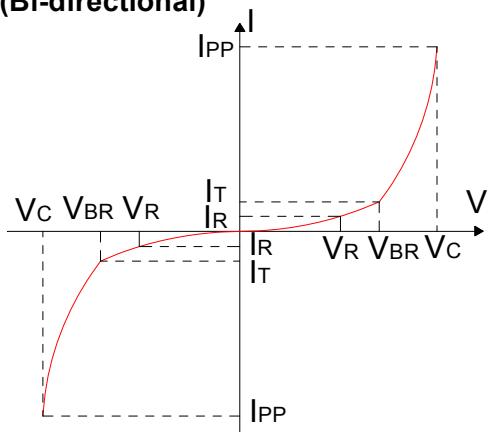
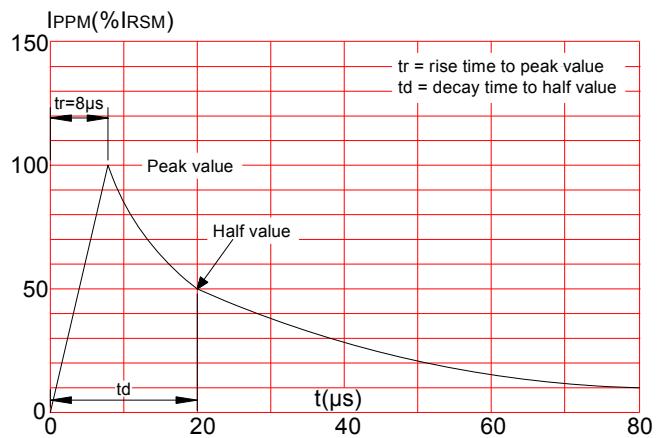
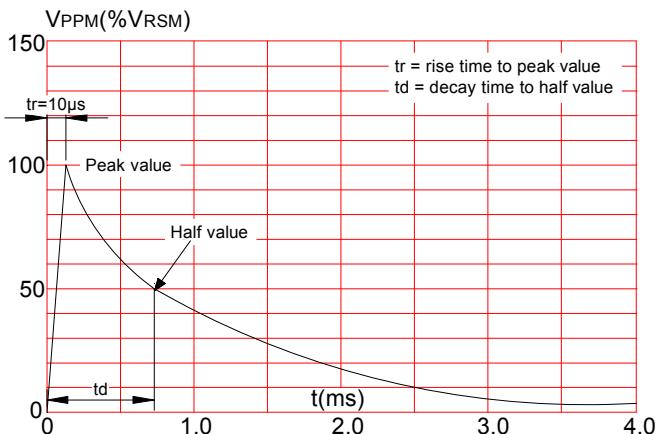
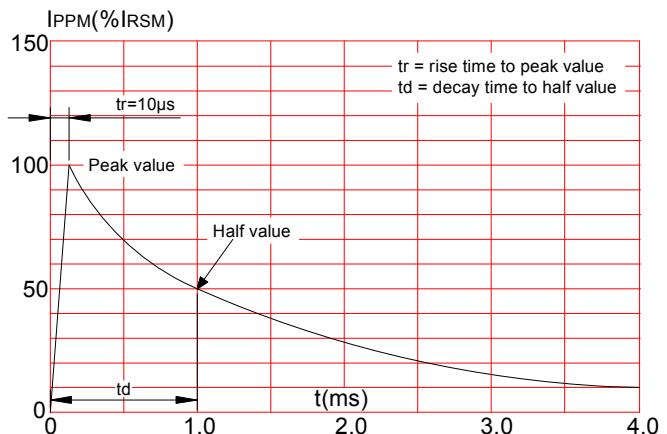
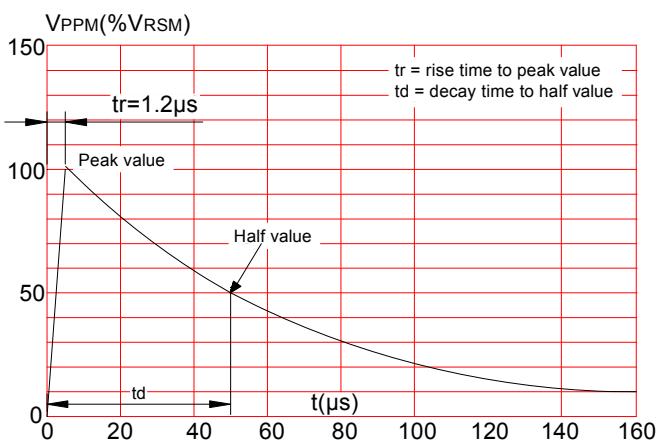
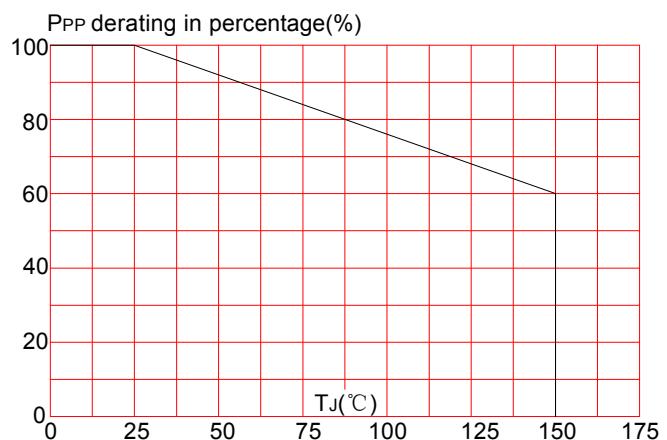
V_R : Stand-off voltage -- Maximum voltage that can be applied

V_{BR} : Breakdown voltage

V_c : Clamping voltage -- Peak voltage measured across the suppressor at a specified surge value

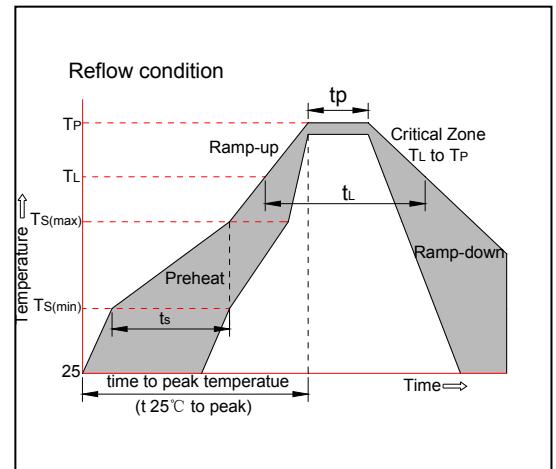
I_R : Reverse leakage current

ORDERING INFORMATION

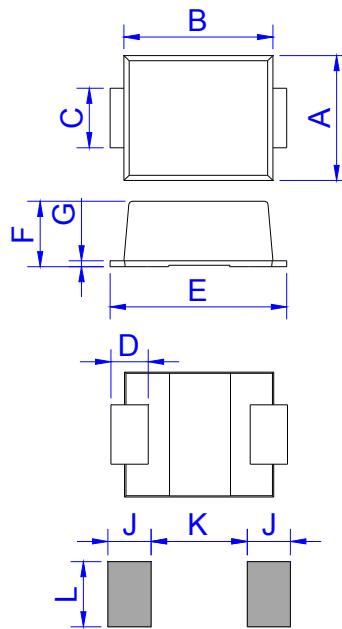
RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)**FIG.1:V- I curve characteristics
(Bi-directional)****FIG.2: Pulse waveform****FIG.3: Pulse waveform****FIG.4: Pulse waveform****FIG.5: Pulse waveform****FIG.6: Pulse derating curve(10/1000μs)**

SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(\min)}$)	+150°C
	-Temperature Max($T_{s(\max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L)to peak)		3°C/sec. Max
$T_{s(\max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C



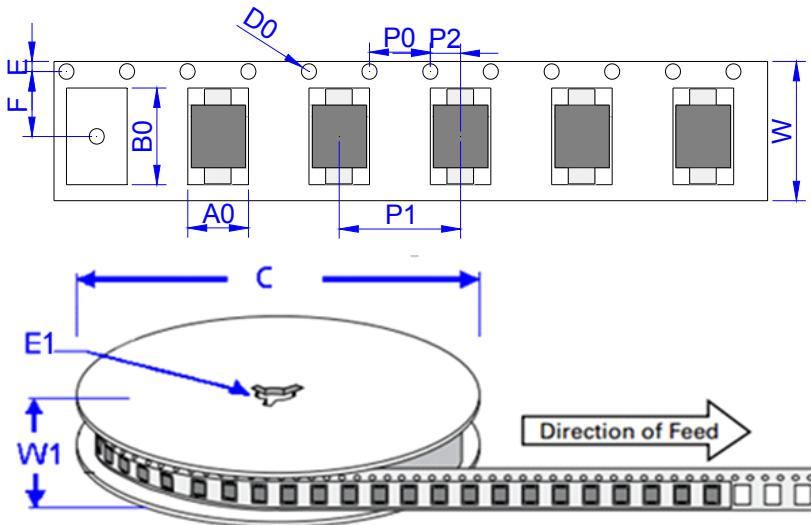
PACKAGE MECHANICAL DATA



SMBF

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	3.90	4.50	0.154	0.177
B	4.65	5.15	0.183	0.203
C	1.85	2.15	0.073	0.085
D	0.60		0.024	
E	5.60	6.00	0.220	0.236
F	2.05	2.35	0.081	0.093
G	0.12	0.28	0.005	0.011
J	2.00		0.079	
K		3.20		0.126
L	2.30		0.091	

TAPE AND REEL SPECIFICATION-SMBF



Ref.	Dimensions	
	Millimeters	Inches
A0	4.50±0.3	0.177 ± 0.012
B0	6.10±0.3	0.240 ± 0.012
C	330.0	13.0
D0	1.55±0.1	0.061 ± 0.004
E	1.75±0.2	0.069 ± 0.008
E1	13.3±0.3	0.524± 0.012
F	5.5±0.2	0.217 ± 0.008
P0	4.00±0.2	0.157 ± 0.008
P1	8.00±0.2	0.315 ± 0.008
P2	2.00±0.2	0.079 ± 0.008
W	12.0±0.2	0.472 ± 0.008
W1	15.7±2.0	0.618 ± 0.079

PART No.	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
15BJ58CA-B	0.13	3,000	48,000	13 inch reel pack

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